

Title (en)  
Integrated metal processing facility

Title (de)  
Integrierte Metallverarbeitungsanlage

Title (fr)  
Installation de traitement de métal intégrée

Publication  
**EP 2319945 A3 20111116 (EN)**

Application  
**EP 10197136 A 20050601**

Previously filed application  
19161 20050601 US

Priority

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- US 57610704 P 20040602

Abstract (en)  
[origin: WO2005121386A2] A system and method for forming and heat treating a metal casting are provided.

IPC 8 full level  
**C21D 11/00** (2006.01); **B22D 46/00** (2006.01); **C21D 9/00** (2006.01); **C22F 1/00** (2006.01); **F27B 9/02** (2006.01); **F27B 9/20** (2006.01); **F27B 9/40** (2006.01); **F27D 19/00** (2006.01); **F27D 21/00** (2006.01); **C21D 1/84** (2006.01)

CPC (source: EP KR)  
**B22D 46/00** (2013.01 - KR); **C21D 6/00** (2013.01 - KR); **C21D 9/0068** (2013.01 - EP KR); **C21D 11/00** (2013.01 - EP KR); **C21D 11/005** (2013.01 - EP); **C22F 1/00** (2013.01 - EP KR); **F27B 9/20** (2013.01 - EP); **F27B 9/40** (2013.01 - EP); **F27D 19/00** (2013.01 - EP); **F27D 21/0014** (2013.01 - EP); **C21D 1/84** (2013.01 - EP)

Citation (search report)

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Designated contracting state (EPC)  
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DOCDB simple family (publication)  
**WO 2005121386 A2 20051222; WO 2005121386 A3 20060316**; CN 101001963 A 20070718; CN 101001963 B 20150819; CN 102000813 A 20110406; CN 102000813 B 20120725; EP 1766100 A2 20070328; EP 1766100 B1 20120808; EP 2319945 A2 20110511; EP 2319945 A3 20111116; EP 2319945 B1 20130313; JP 2008501860 A 20080124; JP 2012040614 A 20120301; JP 2014073531 A 20140424; JP 5575365 B2 20140820; JP 5689403 B2 20150325; KR 20070024675 A 20070302; MX PA06014028 A 20070814

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